

## 201-1600 Aerospace Repair Kit

## Instruction: INS1068

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This kit includes the tools and materials needed to reliably replace damaged lands, surface mount and BGA pads. The Circuit Frames used to replace these conductor patterns do not have an adhesive backing and are bonded to the circuit board surface using epoxy supplied with the kit.

This kit that is specifically designed for Aerospace applications where out-gassing of epoxy may be an issue. All the tools and materials are packaged in a rugged ESD safe carrying case.



See the following instructions pages for more information.

INS1065 Color Agents
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INS1063 Circuit Bond Epoxy
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INS1060 Circuit Frames
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Includes the following items.

Qty	Part No. / Item
1	115-3136 Abrader
1	CFV002AS Circuit Frame
Pkg/5	235-2106-5 Cleaning Brushes
Pkg/5	235-2108-5 Foam Swab, Large
Pkg/60	235-3050 High Temp Tape Discs
Pkg/5	355-3102-5 Micro Probes
5	115-3312 Plastic Cup
1	335-5188 Tweezer, Crossover

Qty	Part No. / Item
4	115-3302 Circuit Bond Epoxy
1	CFV003AS Circuit Frame
Pkg/5	235-2102-5 Foam Swab, 3/16" Tip
Pkg/120	235-3025 High Temp Tape Discs
1	355-0614 Knife with #16 Blades
Pkg/5	115-3315-5 Mixing Picks
1	335-3195 Probe
1	335-5185 Tweezer, Point Tip